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Delay and power calculation standards –

Part 3:
Standard Delay Format (SDF) for the electronic design process

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DELAY AND POWER CALCULATION STANDARDS –

Part 3: Standard Delay Format (SDF) for the electronic design process

FOREWORD

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International Standard IEC/IEEE 61523-3 has been processed through IEC technical committee 93: Design automation.

The text of this standard is based on the following documents:

IEEE Std	FDIS	Report on voting
1497 (2001)	93/191/FDIS	93/196/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives.

The committee has decided that the contents of this publication will remain unchanged until 2006.

IEC 61523 consists of the following parts, under the general title *Delay and power calculation standards*:

IEC 61523-1, Part 1: *Integrated circuit delay and power calculation systems*

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IEC 61523-2, Part 2: *Pre-layout delay calculation specification of CMOS ASIC libraries*

IEC/IEEE 61523-3, Part 3: *Standard Delay Format (SDF) for the electronic process*

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IEEE Standard for Standard Delay Format (SDF) for the Electronic Design Process

Sponsor

Design Automation Standards Committee of the IEEE Computer Society

Approved 5 December 2001

IEEE-SA Standards Board

Abstract: The Standard Delay Format (SDF) is defined in this standard. SDF is a textual file format for representing the delay and timing information of electronic systems. While both human and machine readable, in its most common usage it will be machine written and machine read in support of timing analysis and verification tools, and of other tools requiring delay and timing information. The primary audience for this standard is the implementors of tools supporting the format, but anyone with a need to understand the format's contents will find it useful.

Keywords: computer, computer languages, delay, delay backannotation, digital systems, electronic systems, hardware, hardware design, SDF, timing, timing analysis, timing backannotation, timing verification

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IEEE Introduction

The Standard Delay Format (SDF) was designed to serve as a simple textual medium for communicating timing information and constraints between EDA tools. The original version was designed by Rajit C. Chandra in 1990 while at Cadence Design Systems, and was intended as a means of communicating macrocell and interconnect delays from Gate Ensemble to Verilog-XL, Veritime and other stand-alone tools requiring timing data.

Because it was originally targeted for annotation to tools using the Verilog language, many SDF constructs are analogous to those in Verilog specify blocks. Those already familiar with the Verilog specify block will find many of the SDF constructs familiar, such as SETUP and PATHPULSE. SDF also includes constructs for annotating interconnect delays, and can be used for forward annotation by specifying path delay constraints from timing analysis to floorplanners, and synthesis and layout tools.

SDF was first introduced into the EDA marketplace in 1991 where it won quick acceptance. Cadence placed SDF in the public domain in 1992 when it turned control over to Open Verilog International (OVI), and OVI delivered the first SDF standard, version 2.0, in June, 1993 (SDF version 1.0 was used by Cadence). OVI has since introduced version 2.1 in February, 1994, and version 3.0 in May, 1995. VHDL (IEEE 1076) also takes advantage of SDF through the VITAL standard.

In 1996 the OVI Board of Directors began an effort to establish SDF as an IEEE standard. With the approval of the IEEE Design Automation Standards Committee (DASC), the OVI Logic Modeling Technical Subcommittee became the IEEE SDF Study Group. With the approval of the Project Authorization Request (PAR) by the IEEE Standards Board on February 10, 1997, this group became the IEEE SDF Working Group.

This IEEE SDF standard builds upon OVI SDF version 3.0, and will be known as version 4.0. The changes from OVI 3.0 to IEEE 4.0 are small (LABEL construct added, NETDELAY construct restored), but the change from OVI standard to IEEE standard is significant, and so this is recognized by a new version number.

Objective

The starting point for the IEEE P1497 SDF Working Group was the OVI LRM version 3.0 SDF standard, with the goal of soliciting further enhancements and improving the quality and rigor of the LRM. Since SDF is already in widespread use, no modifications that would invalidate current usage were considered.

Acknowledgments

This standard is based on work originally developed by Cadence Design Systems, Inc. (in SDF 1.0) and Open Verilog International (in SDF 2.0, 2.1 and 3.0). The IEEE is grateful to Cadence Design Systems and Open Verilog International for permission to use their materials as the basis for this standard.

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DELAY AND POWER CALCULATION STANDARDS –
Part 3: Standard Delay Format (SDF)
for the electronic design process

1. Overview

1.1 Scope

The Standard Delay Format (SDF) is an existing OVI standard for the representation and interpretation of timing data for use at any stage of the electronic design process. The ASCII data in the SDF file is represented in a tool and language independent way and includes path delays, timing constraint values, interconnect delays and high level technology parameters. This standard describes the IEEE version of the SDF standard.

This standard should serve as a complete specification of the Standard Delay Format (SDF). It contains:

— Detailed information on how SDF is used in the design process.
— Detailed semantic descriptions of all SDF constructs.
— The formal syntax.
— Examples.

1.2 Organization of this standard

A synopsis of the clauses and annexes of this standard is presented as a quick reference. There are five clauses and two annexes. All the clauses and annexes are normative parts of this standard, with the exception of Annex B (informative).

Clause 1: Overview—Content overview.

Clause 2: References—References to other applicable standards that are assumed or required for SDF.

Clause 3: Definitions and conventions—Introduction to syntactic style and the major syntactic components.

Clause 4: SDF in the design process—The role and use of SDF in the design process.

Clause 5: Defining the Standard Delay Format—The content of an SDF file. For each part of the file, the purpose is discussed, the syntax is specified, the semantics are explained, and examples are presented.

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Annex A: Syntax of SDF—SDF file syntax description. The syntax of the contents of an SDF file is described in this annex.

Annex B: SDF file examples—Informative examples of SDF files.

2. References

This standard shall be used in conjunction with the following publications. When the following standards are superseded by an approved revision, the revision shall apply.

IEEE Std 1076, 2000 Edition, IEEE Standard VHDL Language Reference Manual.[1]

IEEE Std 1364-2001, IEEE Standard Verilog® Hardware Description Language.

[1]IEEE publications are available from the Institute of Electrical and Electronics Engineers, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331, USA (http://standards.ieee.org/).

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